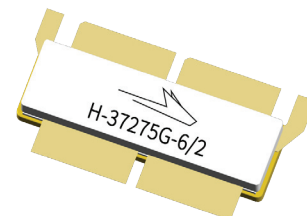


# PXAC213308FV

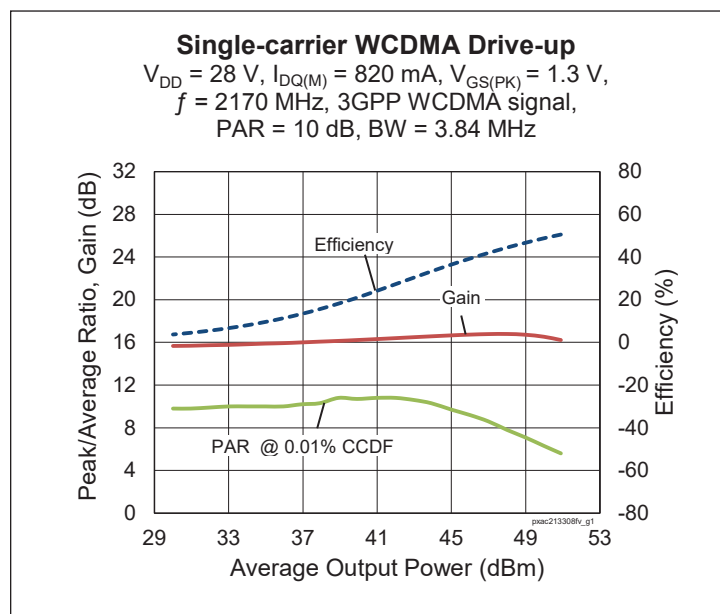
## Thermally-Enhanced High Power RF LDMOS FET 320 W, 28 V, 2110 – 2200 MHz

### Description

The PXAC213308FV is a 320-watt ( $P_{3dB}$ ) LDMOS FET with an asymmetrical design intended for use in multi-standard cellular power amplifier applications in the 2100 to 2200 MHz frequency band. Features include dual-path design, broadband matching, high gain and thermally-enhanced package with earless flanges. Manufactured with Wolfspeed's advanced LDMOS process, this device provides excellent thermal performance and superior reliability.



PXAC213308FV  
Package H-37275G-6/2



### Features

- Broadband internal input and output matching
- Asymmetrical Doherty design
  - Main :  $P_{1dB} = 140\text{ W Typ}$
  - Peak :  $P_{1dB} = 190\text{ W Typ}$
- Typical Pulsed CW performance, 2170 MHz, 28 V, combined outputs
  - Output power at  $P_{3dB} = 320\text{ W}$
  - Efficiency = 53% @  $P_{3dB}$
  - Gain = 16 dB @  $P_{3dB}$
- Capable of handling 10:1 VSWR @ 28 V, 170 W CW output power
- Integrated ESD protection
- Low thermal resistance
- Pb-free and RoHS compliant

### RF Characteristics

#### Single-carrier WCDMA Specifications (tested in Wolfspeed Doherty production test fixture)

$V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 820\text{ mA}$ ,  $V_{GSPEAK} = 1.3\text{ V}$ ,  $P_{OUT} = 55\text{ W avg}$ ,  $f = 2170\text{ MHz}$ , 3GPP signal, channel bandwidth = 3.84 MHz, peak/average = 10 dB @ 0.01% CCDF

Characteristic	Symbol	Min	Typ	Max	Unit
Linear Gain	$G_{ps}$	15.5	16.5	—	dB
Drain Efficiency	$\eta_D$	40	43.5	—	%
Adjacent Channel Power Ratio	ACPR	—	-31	-27	dBc

All published data at  $T_{CASE} = 25^\circ\text{C}$  unless otherwise indicated

ESD: Electrostatic discharge sensitive device—observe handling precautions!



## DC Characteristics (each side)

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}$ , $I_{DS} = 10\text{ mA}$	$V_{(BR)DSS}$	65	—	—	V
Drain Leakage Current	$V_{DS} = 28\text{ V}$ , $V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	1	$\mu\text{A}$
	$V_{DS} = 63\text{ V}$ , $V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	10	$\mu\text{A}$
Gate Leakage Current	$V_{GS} = 10\text{ V}$ , $V_{DS} = 0\text{ V}$	$I_{GSS}$	—	—	1	$\mu\text{A}$
On-State Resistance (Main)	$V_{GS} = 10\text{ V}$ , $V_{DS} = 0.1\text{ V}$	$R_{DS(on)}$	—	0.08	—	$\Omega$
	(Peak) $V_{GS} = 10\text{ V}$ , $V_{DS} = 0.1\text{ V}$	$R_{DS(on)}$	—	0.06	—	$\Omega$
Operating Gate Voltage (Main)	$V_{DS} = 28\text{ V}$ , $I_{DQ} = 850\text{ mA}$	$V_{GS}$	2.5	2.67	2.8	V
	(Peak) $V_{DS} = 28\text{ V}$ , $I_{DQ} = 0\text{ mA}$	$V_{GS}$	1	1.30	1.5	V

## Maximum Ratings

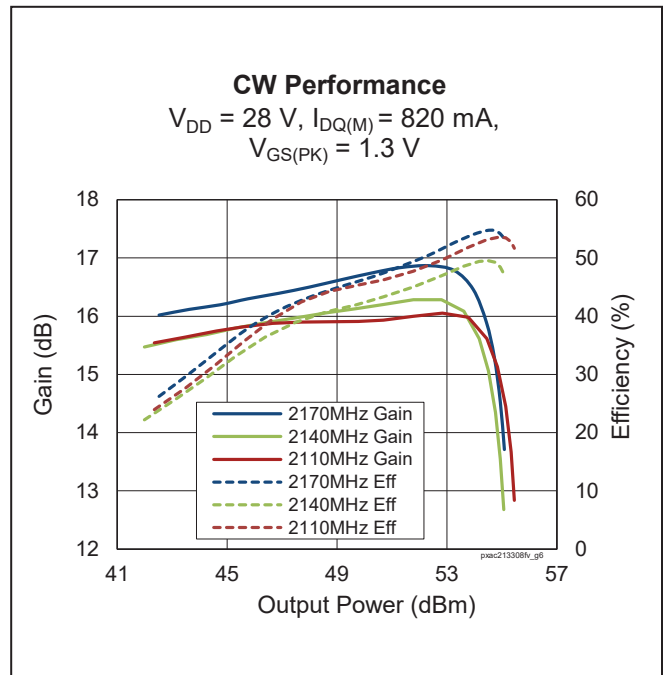
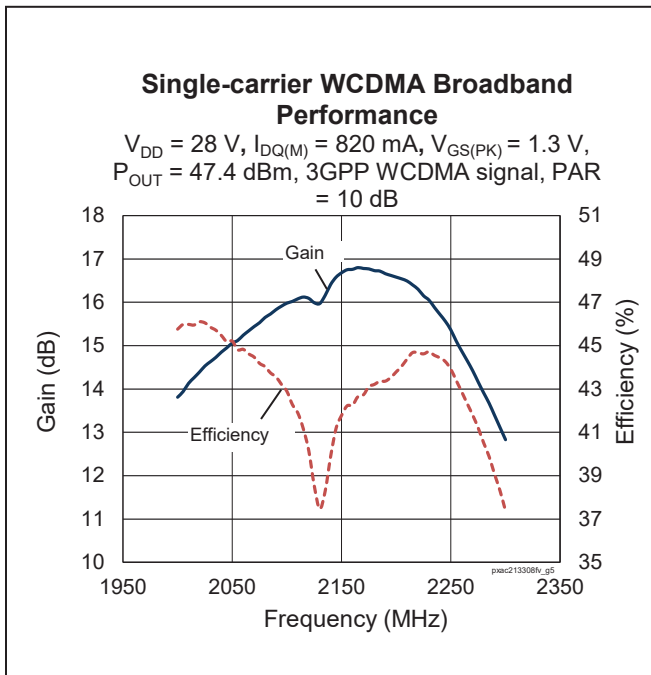
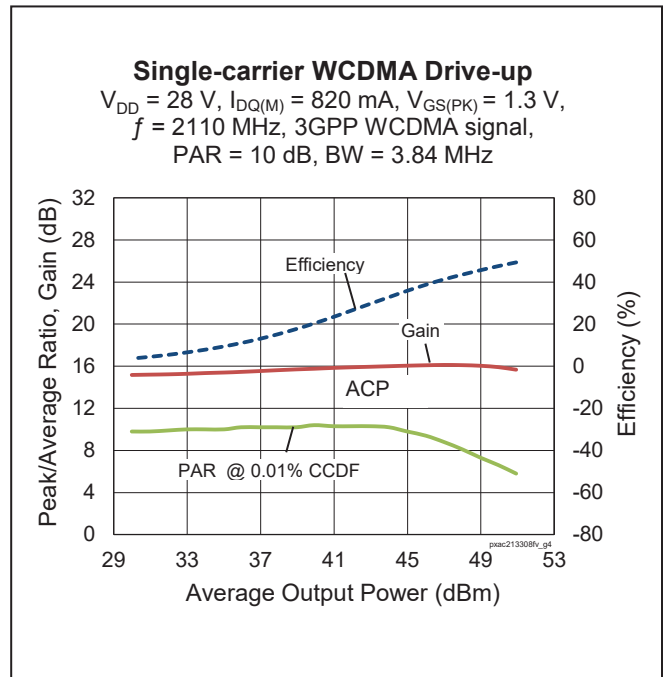
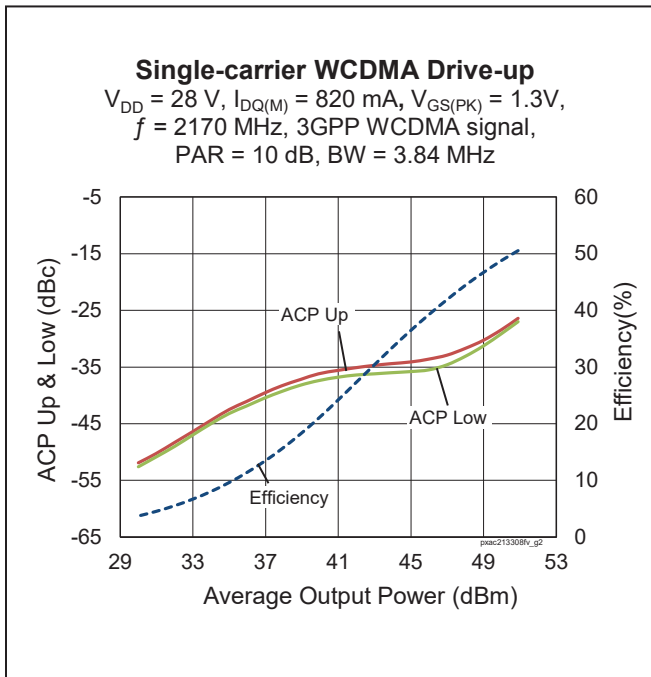
Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	65	V
Gate-Source Voltage	$V_{GS}$	-6 to +10	V
Junction Temperature	$T_J$	225	$^{\circ}\text{C}$
Storage Temperature Range	$T_{STG}$	-65 to +150	$^{\circ}\text{C}$
Thermal Resistance (Main, $T_{CASE} = 70^{\circ}\text{C}$ , 56 W CW)	$R_{\theta JC}$	0.50	$^{\circ}\text{C/W}$
	(Peak, $T_{CASE} = 70^{\circ}\text{C}$ , 140 W CW)	$R_{\theta JC}$	0.24

## Ordering Information

Type and Version	Order Code	Package Description	Shipping
PXAC213308FV V1 R0	PXAC213308FV-V1-R0	H-37275G-6/2, earless flange	Tape & Reel, 50 pcs
PXAC213308FV V1 R2	PXAC213308FV-V1-R2	H-37275G-6/2, earless flange	Tape & Reel, 250 pcs

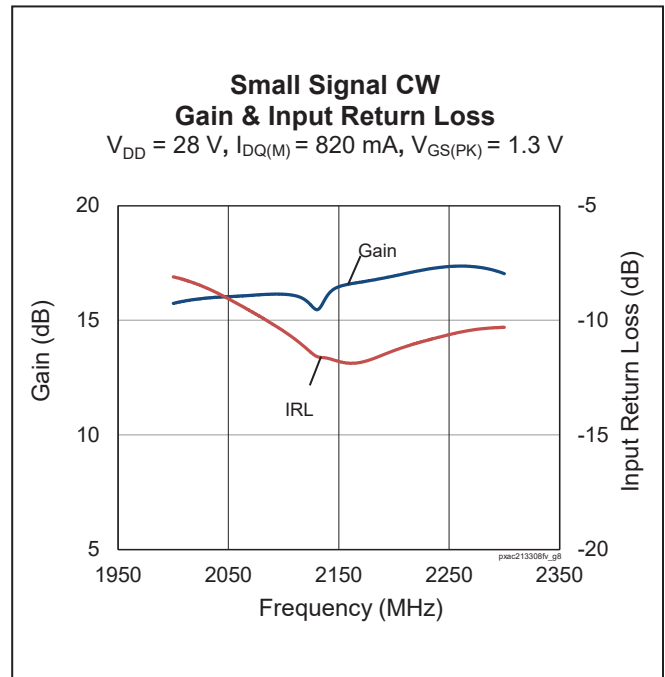
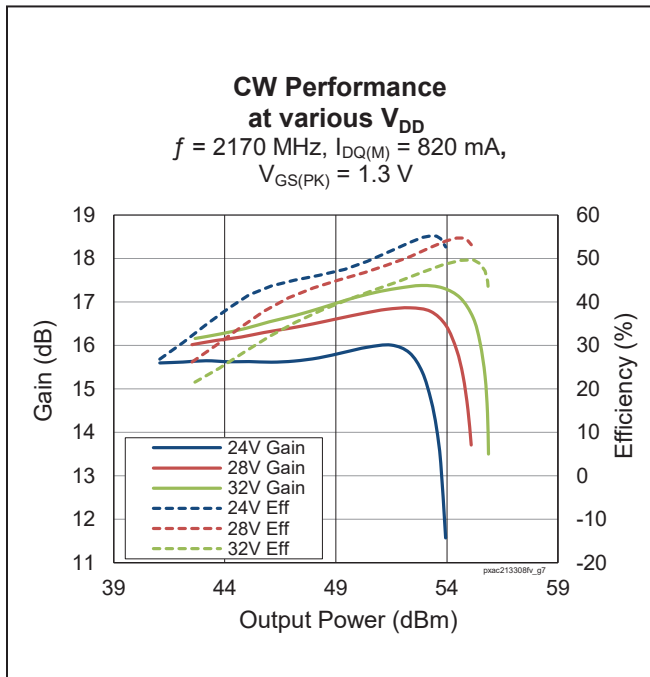


**Typical RF Performance** (data taken in production test fixture)





**Typical RF Performance (cont.)**



**Load Pull Performance**

**Main Side Load Pull Performance** – Pulsed CW signal: 10  $\mu\text{s}$ , 10% duty cycle, 28 V,  $I_{DQ} = 850 \text{ mA}$ , class AB

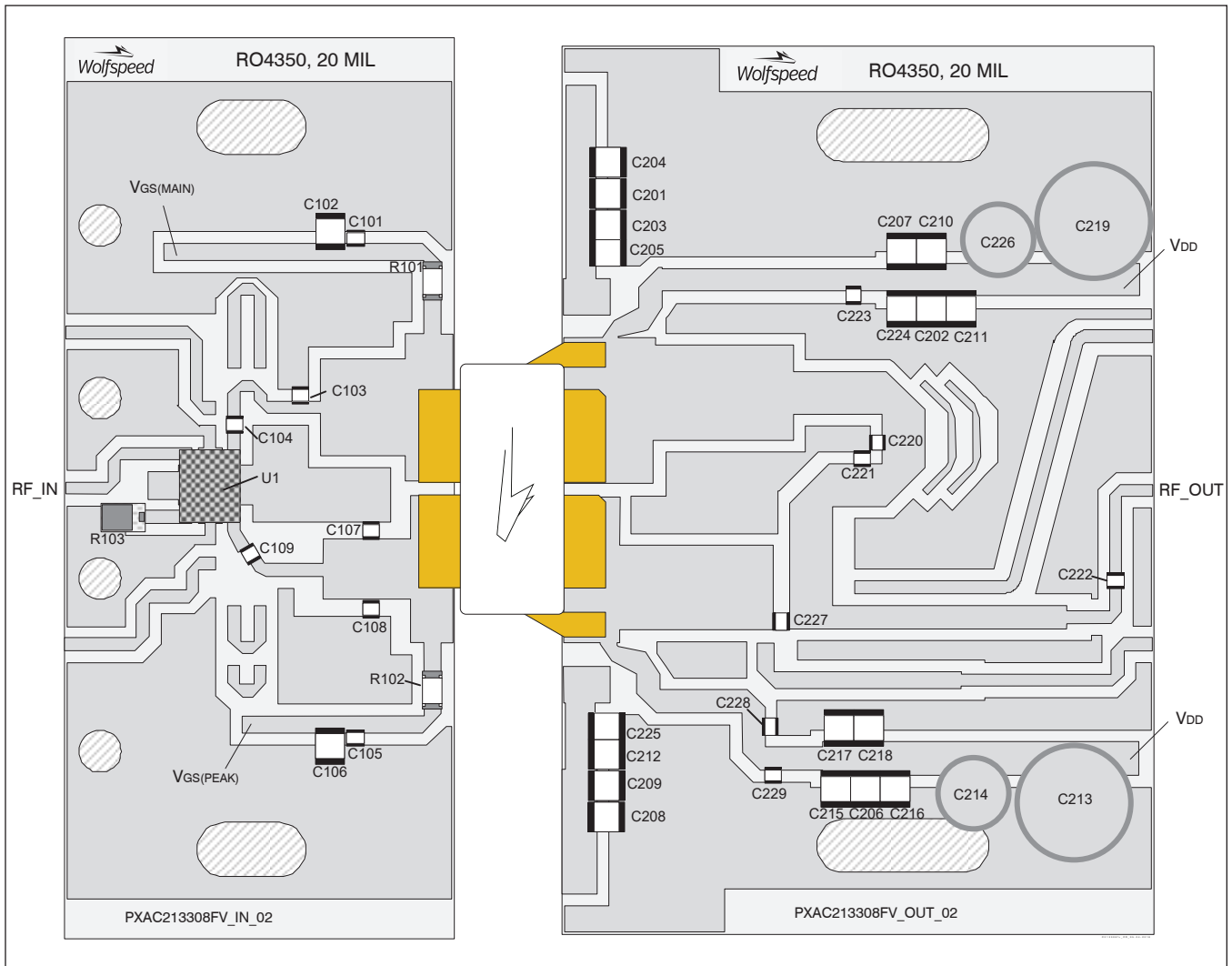
Freq [MHz]	$Z_s$ [ $\Omega$ ]	$P_{1dB}$									
		Max Output Power					Max PAE				
		$Z_l$ [ $\Omega$ ]	Gain [dB]	$P_{OUT}$ [dBm]	$P_{OUT}$ [W]	PAE [%]	$Z_l$ [ $\Omega$ ]	Gain [dB]	$P_{OUT}$ [dBm]	$P_{OUT}$ [W]	PAE [%]
2110	3.1 -j3.95	1.35 -j3.44	17.9	52.54	180	55.0	2.48 -j2.92	19.9	51.25	133	63.0
2140	3.24 -j3.84	1.3 -j3.49	17.7	52.53	179	54.7	2.31 -j2.77	19.8	51.20	131	63.0
2170	3.53 -j3.59	1.25 -j3.52	17.6	52.60	182	54.5	2.23 -j2.82	19.7	51.10	129	62.4
2200	3.6 -j2.99	1.28 -j3.56	17.7	52.44	176	54.0	2.11 -j2.92	19.6	51.17	131	61.5

**Peak Side Load Pull Performance** – Pulsed CW signal: 10  $\mu\text{s}$ , 10% duty cycle, 28 V,  $V_{GS(PEAK)} = 1.3 \text{ V}$ , class C

Freq [MHz]	$Z_s$ [ $\Omega$ ]	$P_{1dB}$									
		Max Output Power					Max PAE				
		$Z_l$ [ $\Omega$ ]	Gain [dB]	$P_{OUT}$ [dBm]	$P_{OUT}$ [W]	PAE [%]	$Z_l$ [ $\Omega$ ]	Gain [dB]	$P_{OUT}$ [dBm]	$P_{OUT}$ [W]	PAE [%]
2110	2.57 -j8	5.37 -j1.04	18.6	53.90	245	54.0	2.11 -j1.23	20.2	51.99	158	62.9
2140	3.27 -j8	3.3 -j8.07	18.5	53.81	240	54.4	2.55 -j1.2	19.9	52.39	174	62.6
2170	4.78 -j8.8	5.54 -j0.9	18.4	53.70	238	53.2	2.15 -j1.72	20.0	51.76	150	62.7
2200	7.5 -j8.4	4.4 -j1.47	17.94	53.70	236	50.5	2.62 -j1.49	19.8	52.29	169	62.7



Reference Circuit, 2110 – 2170 MHz



Reference circuit assembly diagram (not to scale)



**Reference Circuit** (cont.)

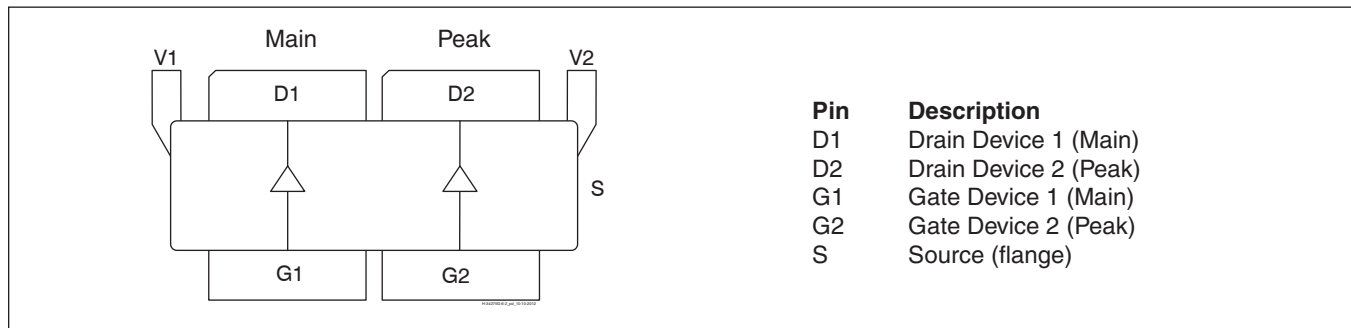
**Reference Circuit Assembly**

DUT	PXAC213308FV V1
Test Fixture Part No.	LTA/PXAC213308FV V1
PCB	Rogers 4350, 0.508 mm [0.020"] thick, 2 oz. copper, $\epsilon_r = 3.66$ , $f = 2110 - 2170$ MHz
Find Gerber files for this test fixture on the Wolfspeed Web site at <a href="http://www.wolfspeed.com/RF">www.wolfspeed.com/RF</a>	

**Components Information**

Component	Description	Manufacturer	P/N
<b>Input</b>			
C101, C104, C105, C109	Capacitor, 18 pF	ATC	ATC100A180JW150XB
C102, C106	Capacitor, 10 $\mu$ F	Taiyo Yuden	UMK325C7106MM-T
C103	Capacitor, 0.9 pF	ATC	ATC100A0R9CW150XB
C107	Capacitor, 0.4 pF	ATC	ATC100A0R4CW150XB
C108	Capacitor, 0.2 pF	ATC	ATC100A0R2CW150XB
R101, R102	Resistor, 5.1 $\Omega$	Panasonic Electronic Components	ERJ-8GEYJ5R1V
R103	Resistor, 50 $\Omega$	Richardson	C8A50Z4A
U1	Hybrid coupler	Anaren	X3C21P1-04S
<b>Output</b>			
C201, C202, C203, C204, C205, C206, C207, C208, C209, C210, C211, C212, C215, C216, C224, C217, C218, C225	Capacitor, 10 $\mu$ F	Taiyo Yuden	UMK325C7106MM-T
C213, C219	Capacitor, 220 $\mu$ F	Panasonic Electronic Components	ECA-2AHG221
C214, C226	Capacitor, 220 $\mu$ F	Panasonic Electronic Components	EEE-FP1V221AP
C220	Capacitor, 0.4 pF	ATC	ATC100A0R4CW150XB
C221	Capacitor, 0.2 pF	ATC	ATC100A0R2CW150XB
C222, C227	Capacitor, 20 pF	ATC	ATC100A200JW150XB
C223, C228, C229	Capacitor, 18 pF	ATC	ATC100A180JW150XB

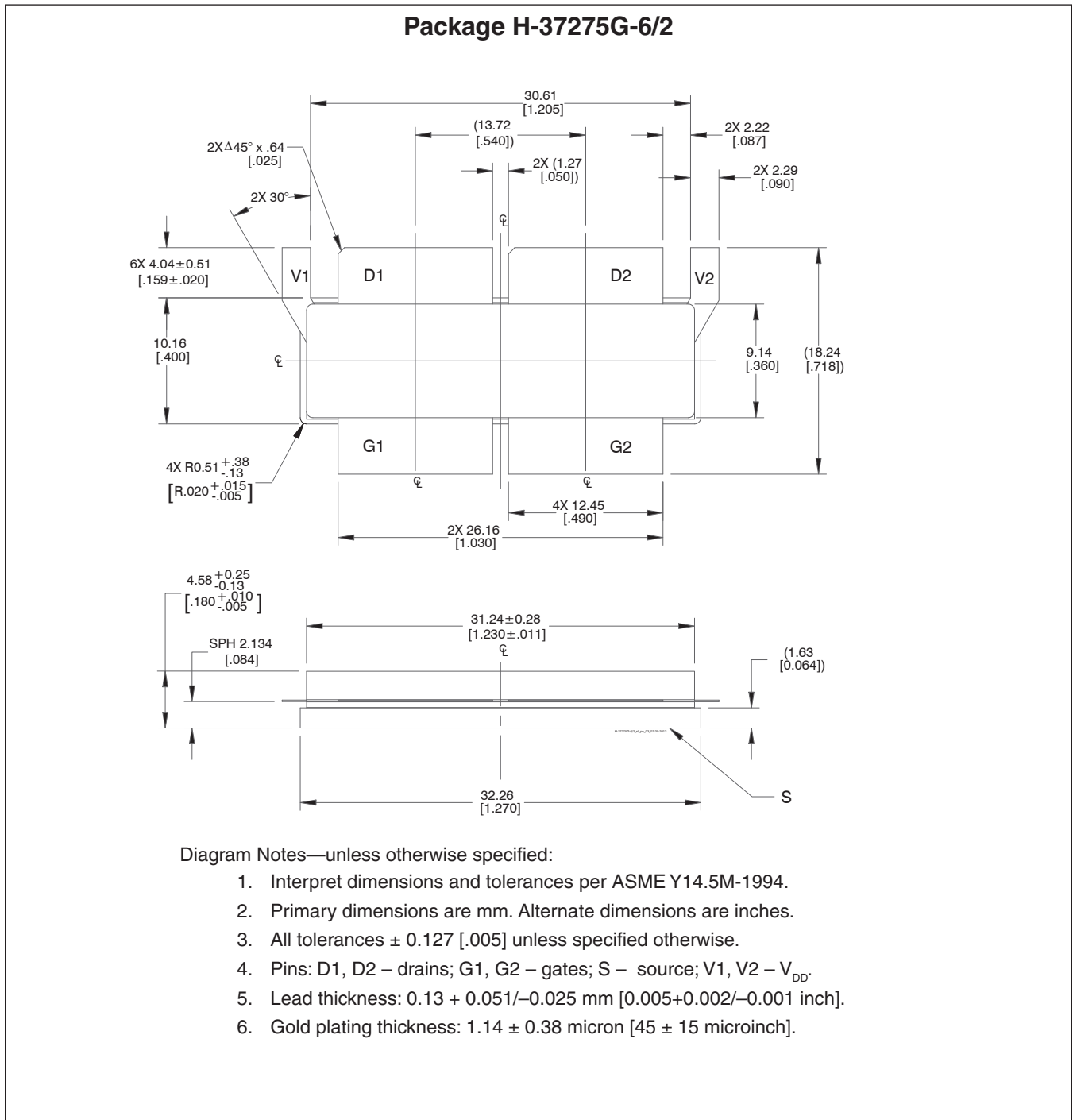
**Pinout Diagram** (top view)



Lead connections for PXAC213308FV



Package Outline Specifications



## Revision History

Revision	Date	Data Sheet Type	Page	Subjects (major changes since last revision)
01	2015-07-23	Advance	All	Data Sheet reflects advance specification for product development
02	2016-05-04	Production	All	Data Sheet reflects released product specification
03	2018-07-02	Production	All	Converted to Wolfspeed Data Sheet

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## Notes

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